First Edition Sep 1, 2005

LCD Module Technical Specification

Final Revision

Type No.

C-51505NFJ-SLG-AHN

m. Abatrated

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Revision History

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1.General Specifications

Operating Temp.	:	min20°C ~ max. 70°C
Storage Temp.	:	min20°C ~ max. 70°C
Display Format	:	20 characters × 2 lines
Display Fonts	:	5 × 8 dots (1 character)
Viewing Area	:	83.0 (W) × 18.6 (H) mm
Outline Dimensions	:	116.0 (W) × 37.0 (H) × (15.6) (D) mm
Weight	:	42.9g max.
LCD Type	:	NSD-21334 (F-STN / Black&White-mode / Transflective)
Viewing Angle	:	6:00
Data Transfer	:	8-bit parallel data transfer
Backlight	:	LED Backlight / Green
Drawings	:	Dimensional Outline C-51505 AH base
RoHS regulation	:	To our best knowledge, this product satisfies material requirement of RoHS regulation. Our company is doing the best efforts to obtain the equivalent certificate from our suppliers.

2.Electrical Specifications

2.1. Absolute Maximum Ratings

					Vss=0V
Parameter	Symbol	Conditions	Min.	Max.	Units
Supply Voltage	Vcc-Vss	-	-0.3	7.0	V
(Logic)					
Supply Voltage	Vcc-Vee	-	-0.3	13.5	V
(LCD Drive)					
Input Voltage	Vi	-	-0.3	Vcc+0.3	V

2.2. DC Characteristics

Ta=25°C, Vcc=5V, Vss=Vee=0V

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Supply Voltage	Vcc-Vss	-	4.5	-	5.5	V
(Logic)						
Supply Voltage	Vcc-Vee		Shown in 3	.1		V
(LCD Drive)						
High Level	Vін	-	2.2	-	Vcc	V
Input Voltage						
Low Level	Vil	-	-0.3	-	0.8	V
Input Voltage						
High Level	Vон	lон=-0.25mA	2.4	-	-	V
Output Voltage						
Low Level	Vol	lo∟=1.2mA	-	-	0.4	V
Output Voltage						
Supply Current	lcc	Vcc-Vss=5.3V	-	2.0	3.0	mA

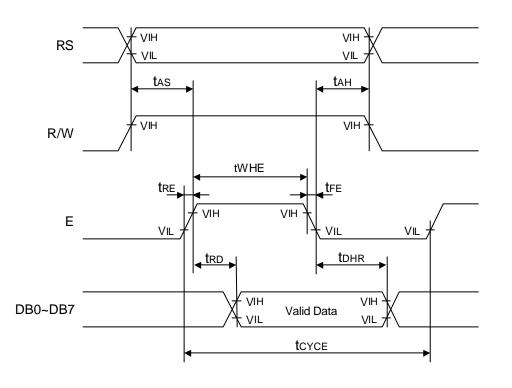
All voltage values are referenced to Vss =0V

 $V_1 \text{ to } V_5 \text{ must maintain } V_{DD} \geq V_1 \geq V_2 \geq V_3 \geq V_4 \geq \!\! V_5 \!\!.$

2.3. AC Characteristic

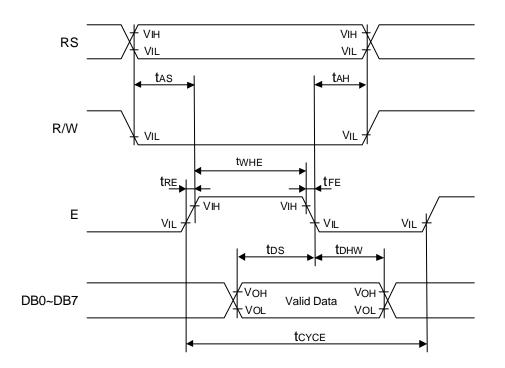
Read Operation

			Vcc=	5.0V±10%
Parameter	Symbol	Min.	Max.	Units
Enable Cycle Time	t _{CYCE}	500	-	ns
Enable "H" Level Pulse Width	t _{whe}	300	-	ns
Enable Rise/Fall Time	$t_{\text{RE}}, t_{\text{FE}}$	-	25	ns
RS,R/W Setup Time (8-bit operation mode) (4-bit operation mode)	t _{AS}	60 100	-	ns
RS,R/W Address Hold Time	t _{AH}	10	-	ns
Read Data Output Delay	t _{RD}	-	190	ns
Read Data Hold Time	t _{DHR}	20	-	ns



Read Operation Timing

Write Operation				
	•		Vcc=	5.0V±10%
Parameter	Symbol	Min.	Max.	Units
Enable Cycle Time	t _{CYCE}	500	-	ns
Enable "H" Level Pulse Width	t _{whe}	300	-	ns
Enable Rise/Fall Time	t _{re,} t _{re}	-	25	ns
RS,R/W Setup Time (8-bit operation mode) (4-bit operation mode)	t _{AS}	60 100	-	ns
RS,R/W Address Hold Time	t _{AH}	10	-	ns
Data Output Delay	t _{DS}	-	-	ns
Data Hold Time	t _{DHR}	10	_	ns



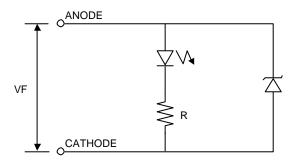
Write Operation Timing

2.4. Lighting Specifications (LED Unit)

2.4.1. Absolute Maximum Ratings

	Ũ					Ta=25°C
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Forward Voltage	VF	Note 1	-	-	6.0	V
LED Power Dissipation	PD	-	-	-	0.125	mW
Reverse Voltage	Vr	-	-	-	5.0	V

Note 1 : VF is defined as the voltage between ANODE and CATHODE as shown below.



2.4.2. Operating Characteristics

						Ta=25°C
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Foward Current	lF	VF=5.0V	-	15	18	mA
Luminance of	L	VF=5.0V	160	-	-	cd/m ²
Backlight Surface						

3. Optical Specifications

3.1.LCD Driving Voltage

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Recommended		Ta=-20°C	-	-	5.5	V
LCD Driving Voltage	Vcc-Vee	Ta=25°C	4.9	5.3	5.5	V
Note 1		Ta=70°C	4.7	-	-	V

Note 1 : Voltage (Applied actual waveform to LCD Module) for the best contrast. The range of minimum and maximum shows tolerance of the operating voltage. The specified contrast ratio and response time are not guaranteed over the entire range.

3.2. Optical Characteristics

Ta=25°C, 1/16 Duty, 1/5 Bias, Von=5.3V (Note 4), θ= 0°, φ=-°

Pa	rameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Contrast Ra	atio Note 1	CR	$\theta = 0^{\circ}, \phi = -^{\circ}$	-	5	-	
Viewing Ang	gle		Shown in 3.3				
Response	Rise Note 2	Τον	-	-	80	160	ms
Time	Decay Note 3	Toff	-	-	110	200	ms

Note 1 :Contrast ratio is definded as follows.(CR = LOFF / LON)

LON : Luminance of the ON segments

LOFF: Luminance of the OFF segments

Measuring Spot:0.9mm

Note 2 :The time that the luminance level reaches 90% of the saturation level from 0% when ON signal is applied.

Note 3 :The time that the luminance level reaches 10% of the saturation level from 100% when OFF signal is applied.

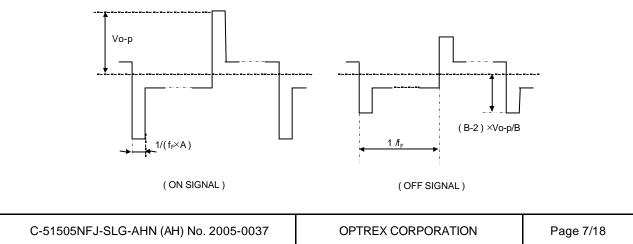
Note 4 :Definition of Driving Voltage Vod

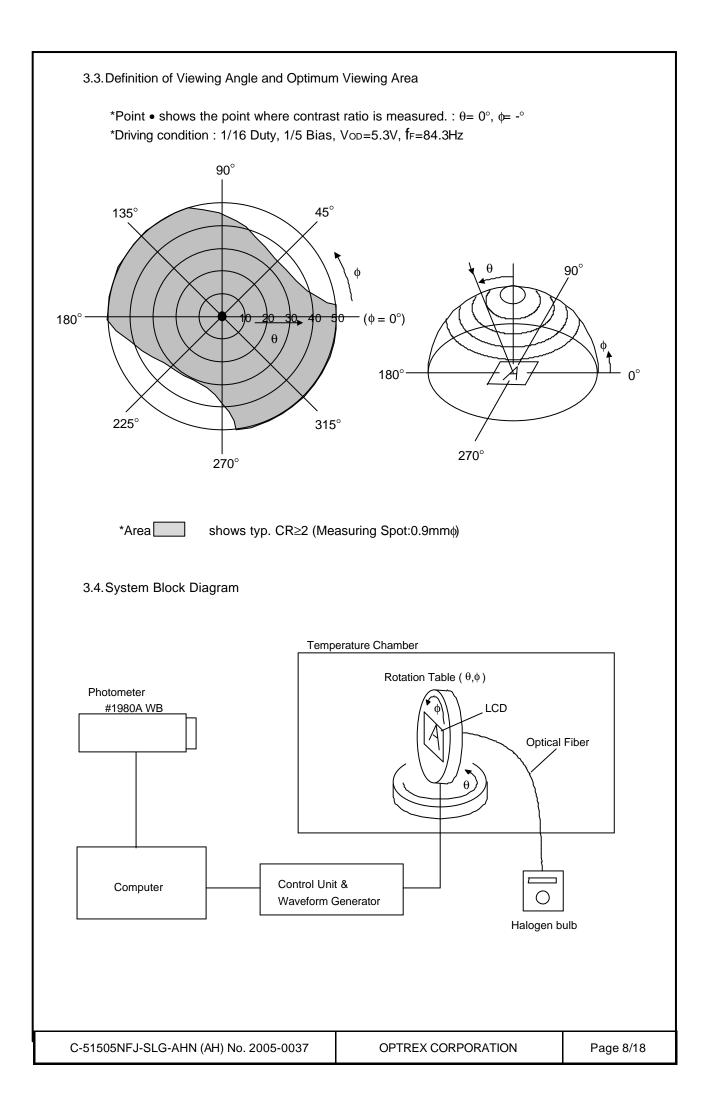
VOD=VCC-VADJ-VBE

Assuming that the typical driving waveforms shown below are applied to the LCD Panel at 1/A Duty - 1/B Bias (A: Duty Number, B: Bias Number). Driving voltage Vod is definded as follows.

Vop = (Vth1+Vth2) / 2

- Vth1: The voltage Vo-P that should provide 70% of the saturation level in the luminance at the segment which the ON signal is applied to.
- Vth2: The voltage V_{O-P} that should provide 20% of the saturation level in the luminance at the segment which the OFF signal is applied to.





4.I/O Terminal

4.1.Pin Assignment

<u>CN1</u>

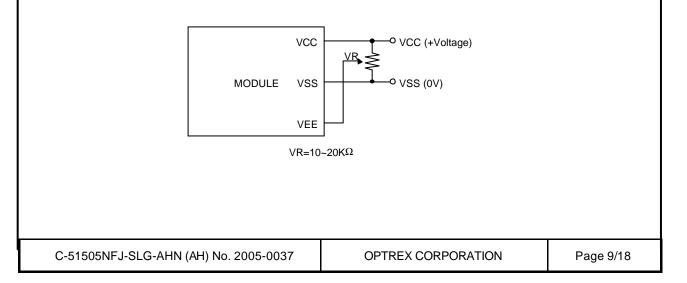
No.	Symbol	Function
1	LED (A)	LED Anode Terminal
2	LED (K)	LED Cathode Terminal
3	Vss	Power Supply (0V, GND)
4	Vcc	Power Supply for Logic
5	Vee	Power Supply for LCD Drive
6	RS	Register Select Signal
7	R/W	Read/Write Select Signal H : Read L : Write
8	E	Enable Signal (No pull-up Resister)
9	DB0	Data Bus Line / Non-connection at 4-bit operation
10	DB1	Data Bus Line / Non-connection at 4-bit operation
11	DB2	Data Bus Line / Non-connection at 4-bit operation
12	DB3	Data Bus Line / Non-connection at 4-bit operation
13	DB4	Data Bus Line
14	DB5	Data Bus Line
15	DB6	Data Bus Line
16	DB7	Data Bus Line

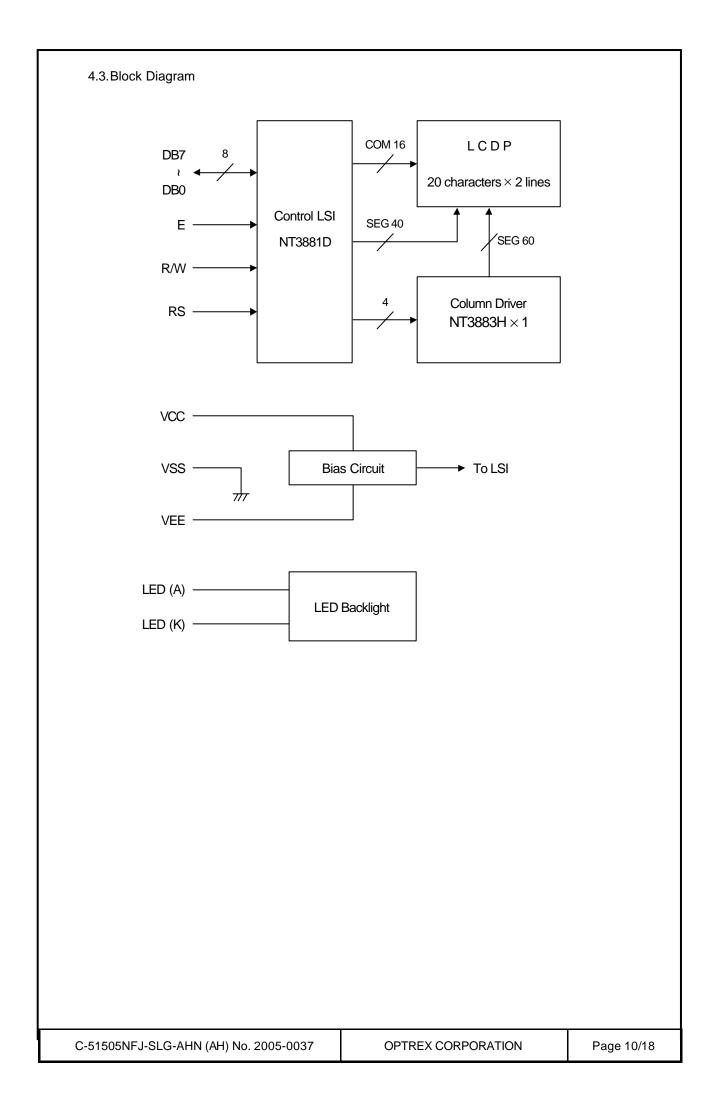
<u>CN2</u>

No.	Symbol	Function
17	LED (A)	LED Anode Terminal
18	LED (K)	LED Cathode Terminal

4.2. Example of Power Supply

It is recommended to apply a potentiometer for the contrast adjust due to the tolerance of the driving voltage and its temperature dependence.





<u>5.Test</u>

No change on display and in operation under the following test condition.

Conditions: Unless otherwise specified, tests will be conducted under the following condition. Temperature: 20±5°C Humidity : 65±5%RH tests will be not conducted under functioning state.

No.	Parameter	Conditions	Notes
1	High Temperature Operating	70°C±2°C, 96hrs (operation state)	
2	Low Temperature Operating	-20°C±2°C, 96hrs (operation state)	1
3	High Temperature Storage	70°C±2°C, 96hrs	2
4	Low Temperature Storage	-20°C±2°C, 96hrs	1,2
5	Damp Proof Test	40°C±2°C,90~95%RH, 96hrs	1,2
6	Vibration Test	Total fixed amplitude : 1.5mm Vibration Frequency : 10~55Hz	3
		One cycle 60 seconds to 3 directions of X, Y, Z for each 15 minutes	
7	Shock Test	To be measured after dropping from 60cm high on the concrete surface in packing state.	

Note 1 :No dew condensation to be observed.

Note 2 :The function test shall be conducted after 4 hours storage at the normal Temperature and humidity after removed from the test chamber.

Note 3 :Vibration test will be conducted to the product itself without putting it in a container.

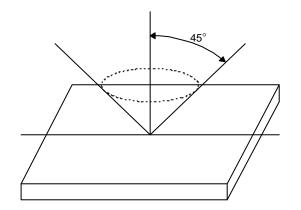
6.Appearance Standards

6.1. Inspection conditions

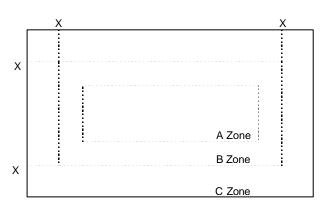
The LCD shall be inspected under 40W white fluorescent light.

The distance between the eyes and the sample shall be more than 30cm.

All directions for inspecting the sample should be within 45° against perpendicular line.



6.2. Definition of applicable Zones



X : Maximum Seal Line

A Zone : Active display area

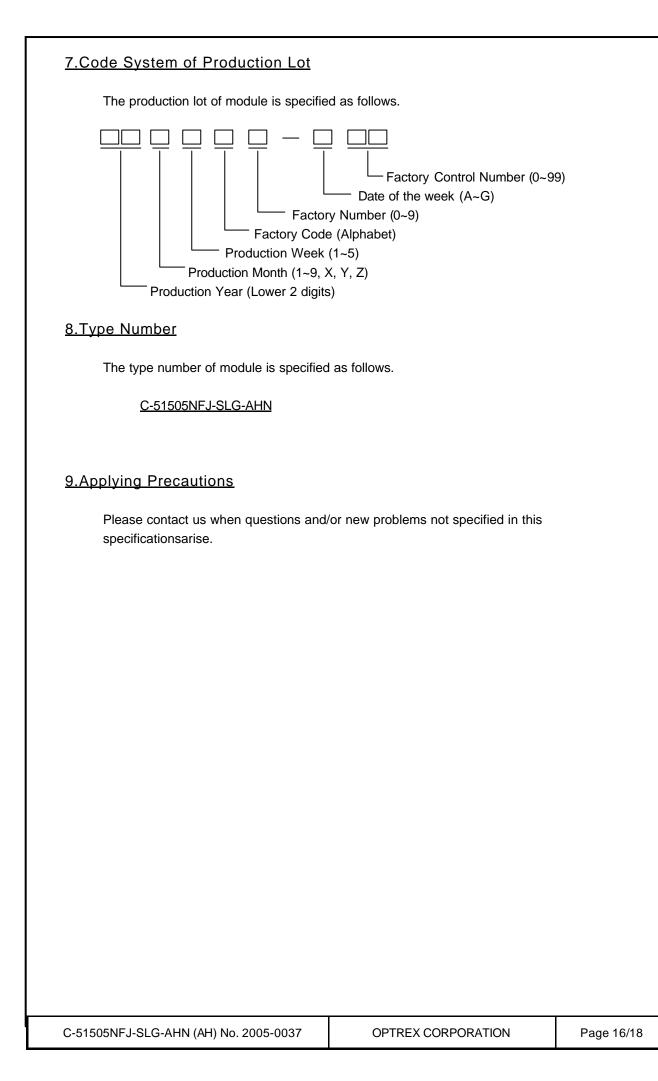
- B Zone : Out of active display area ~ Maximum seal line
- C Zone : Rest parts

A Zone + B Zone = Validity viewing area

No.	D = (Long + Short) / 2 * : Disregard						
1 1	Parameter The Shape of Dot	Criteria (1) Pin Hole					
I	The Shape of Dol		Dimensio	n	Accontable	Numbor	
					Acceptable	number	
			D ≤ 0	.10		amont) or loo	
			0.10 < D ≤ 0.	15	1 pc / dot(only se 2 pcs / cell or les		
		(2) Pattern Shi	(2) Pattern Shift				
		A B	A − B ←	≤ 0.15			
		(3) Breakage o	or Chips / Defor	mation			
		А	1.Segment Typ	be			
			Dimensio	n	Acceptable	Number	
			A ≤ 0.10)	*		
			B ≤ 0.10)	*		
		-→ B	2.Dot Type				
		А	Dimension		Acceptable Nu	mber	
			A≤0.10	(Shou	* ould not be connected to ne		
					dot(only segment		
			0.10 <a≤0.15< td=""><td>-</td><td>/ cell or less</td><td></td></a≤0.15<>	-	/ cell or less		
		В		-	Id not be connected	ed to next dot	
			B ≤ 0.10		*		
		3.0	Defective type e	extends	over multiple num	bers of dots	
			Dimension		Acceptable Nu	mber	
			D≤0.10		*		
		I¥₽₽	1 pc / dot(only segment)or less 2 pcs / cell or less 0.10 <d≤0.15< td=""><td>)or less</td></d≤0.15<>)or less	
			(Individual dot must secure 1/2				
				or mo	ore)		

No.	Parameter	Criteria						
2	Black and	(1) Round Shape						
	White Spots,	Zone	Acc	ceptable Numb	ber			
	Foreign Substances	Dimension	А	В	С			
		D ≤ 0.10	*	*	*			
		0.10< D ≤ 0.20	6	6	*			
		$0.20 < D \le 0.30$	2	2	*			
		Individual dot must secure 1	/2 area or mor	ſe.				
		(2) Line Shape						
		Zone		Acceptable Number				
		Length Width	<u> </u>	B	C *			
		L ≤2.0 W≤0.0		*	*			
		L ≤2.0 0.03 <w≤0.05< td=""><td></td><td>4</td><td>*</td></w≤0.05<>		4	*			
		* 0.05 <w No more than 7pcs as total</w 		me way (1)	~			
3	Color Variation	(Refer to "Complex Foreign Substance Defects") Not to be conspicuous defects.						
4	Air Bubbles	N						
	(between glass	Zone	Acc	ceptable Numb	ber			
	& polarizer)	Dimension	A	В	С			
		D ≤ 0.15	*	*	*			
		0.15< D ≤ 0.30	2	3	*			
		0.30< D ≤ 0.50	1	2	*			
		0.50< D ≤ 1.00	0	1	*			
		No more than 3pcs as total (Refer to "Complex Foreign		ects")				
5	Polarizer Scratches	Not to be conspicuous defect	ts.					
0		If the stains are removed easily from LCDP surface, the module is not defective.						
6	Polarizer Dirts	not defective.		Black spots, line shaped foreign substances or air bubbles betweer				
	Complex Foreign		ign substances	s or air bubble	s betweer			
6			-		s betweer			
6	Complex Foreign	Black spots, line shaped fore	-		s betweer			
6 7	Complex Foreign Substance Defects	Black spots, line shaped fore glass & polarizer should be 7	-		s betweer			

No.ParameterCriteria9Chipped Glass(1) Other than electrode pad areas and corner areas		I		D = (l	ong + Shor	t)/2 *:	Disrega	ard Units : mr
$\frac{1}{1000} \frac{1}{1000} \frac{1}{1000} \frac{1}{1000} \frac{1}{10000} \frac{1}{10000000000000000000000000000000000$	No.	Parameter	Criteria					
$\frac{x Y Z x Y Z}{* \le 0.4 * * \le 0.3 * \le 2.5 \le 0.7 =t \le 2.0 \le 0.5 =t \le 3.5 \le 1.0 \le 1/2t \le 3.0 \le 0.5 \le 1/2t \le 5.5 \le 1.5 \le 1/3t \le 4.5 \le 1.2 \le 1/3t \le 4.5 \le 1.2 \le 1/3t \le 4.5 \le 1.2 \le 1/3t = 1/$	9	Chipped Glass	(1) Other than electrode pad areas and corner areas					
$\frac{ }{ $			"A" si	ze:0.82or m	ore	"A" siz	e:Less	than 0.82
$3.0.4 \qquad \qquad$			Х	Y	Z	Х	Y	Z
$\frac{\leq 3.5 \leq 1.0 \leq 1/2t \leq 3.0 \leq 0.5 \leq 1/2t}{\leq 5.5 \leq 1.5 \leq 1/3t \leq 4.5 \leq 1.2 \leq 1/3t}$ (2) Corner Areas 1.Lead Areas $\frac{\langle A^{"} \text{ size} \\ H^{"} \text$			*	≤0.4	*	*	≤0.	3 *
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $			≤2.5	≤0.7	=t	≤2.0	≤0.	5 =t
(2) Corner Areas 1.Lead Areas $\begin{array}{c} $			≤3.5	≤1.0	≤1/2t	≤3.0	≤0.	5 ≤1/2t
1.Lead Areas"A" size $0.82or moreLess than 0.82X+Y4.0 \le 3.02.Other than electrode pad Areas\sqrt{x}$			≤5.5	≤1.5	≤1/3t	≤4.5	≤1.	2 ≤1/3t
Image: A matrix of the sizeImage: A matrix of the sizeImag								
XY0.82or moreLess than 0.82X+YX+YX+Y ≤ 3.0 ≤ 2.0 The total number of chipped glass defects shall be up to 5 spots. The chipped glass shall be judged only from the size of the defect.			2.Other					"^" -:
X+YX+Y ≤ 3.0 ≤ 2.0 The total number of chipped glass defects shall be up to 5 spots. The chipped glass shall be judged only from the size of the defect.								
$\leq 3.0 \leq 2.0$ The total number of chipped glass defects shall be up to 5 spots. The chipped glass shall be judged only from the size of the defect.								
The total number of chipped glass defects shall be up to 5 spots. The chipped glass shall be judged only from the size of the defect.								
			The chipped	d glass shal	l be judged	only from t	he size	of the defect.



10.Precautions Relating Product Handling

The Following precautions will guide you in handling our product correctly.

- 1) Liquid crystal display devices
- 1. The liquid crystal display device panel used in the liquid crystal display module is made of plate glass. Avoid any strong mechanical shock. Should the glass break handle it with care.
- 2. The polarizer adhering to the surface of the LCD is made of a soft material. Guard against scratching it.
- 2) Care of the liquid crystal display module against static electricity discharge.
- 1. When working with the module, be sure to ground your body and any electrical equipment you may be using. We strongly recommend the use of anti static mats (made of rubber), to protect work tables against the hazards of electrical shock.
- 2. Avoid the use of work clothing made of synthetic fibers. We recommend cotton clothing or other conductivity-treated fibers.
- 3. Slowly and carefully remove the protective film from the LCD module, since this operation can generate static electricity.
- 3) When the LCD module alone must be stored for long periods of time:
- 1. Protect the modules from high temperature and humidity.
- 2. Keep the modules out of direct sunlight or direct exposure to ultraviolet rays.
- 3. Protect the modules from excessive external forces.
- 4) Use the module with a power supply that is equipped with an overcurrent protector circuit, since the module is not provided with this protective feature.
- Do not ingest the LCD fluid itself should it leak out of a damaged LCD module. Should hands or clothing come in contact with LCD fluid, wash immediately with soap.
- 6) Conductivity is not guaranteed for models that use metal holders where solder connections between the metal holder and the PCB are not used. Please contact us to discuss appropriate ways to assure conductivity.
- 7) For models which use CFL:
- 1. High voltage of 1000V or greater is applied to the CFL cable connector area. Care should be taken not to touch connection areas to avoid burns.
- 2. Protect CFL cables from rubbing against the unit and thus causing the wire jacket to become worn.
- 3. The use of CFLs for extended periods of time at low temperatures will significantly shorten their service life.
- 8) For models which use touch panels:
- 1. Do not stack up modules since they can be damaged by components on neighboring modules.
- 2. Do not place heavy objects on top of the product. This could cause glass breakage.
- 9) For models which use COG,TAB,or COF:
 - 1. The mechanical strength of the product is low since the IC chip faces out unprotected from the rear.
 - Be sure to protect the rear of the IC chip from external forces.
 - 2. Given the fact that the rear of the IC chip is left exposed, in order to protect the unit from electrical damage, avoid installation configurations in which the rear of the IC chip runs the risk of making any electrical contact.

- 10)Models which use flexible cable, heat seal, or TAB:
- 1. In order to maintain reliability, do not touch or hold by the connector area.
- 2. Avoid any bending, pulling, or other excessive force, which can result in broken connections.
- 11) In case of buffer material such as cushion / gasket is assembled into LCD module, it may have an adverse effect on connecting parts (LCD panel-TCP / HEAT SEAL / FPC / etc., PCB-TCP / HEAT SEAL / FPC etc., TCP-HEAT SEAL, TCP-FPC, HEAT SEAL-FPC, etc.,) depending on its materials. Please check and evaluate these materials carefully before use.
- 12) In case of acrylic plate is attached to front side of LCD panel, cloudiness (very small cracks) can occur on acrylic plate, being influenced by some components generated from polarizer film.. Please check and evaluate those acrylic materials carefully before use.

11.Warranty

This product has been manufactured to your company's specifications as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in medical devices, nuclear power control equipment, aerospace equipment, fire and security systems, or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required. If the product is to be used in any of the above applications, we will need to enter into a separate product liability agreement.

- 1. We cannot accept responsibility for any defect, which may arise from additional manufacturing of the product (including disassembly and reassembly), after product delivery.
- 2. We cannot accept responsibility for any defect, which may arise after the application of strong external force to the product.
- We cannot accept responsibility for any defect, which may arise due to the application of static electricity after the product has passed your company's acceptance inspection procedures.
- 4. When the product is in CFL models, CFL service life and brightness will vary according to the performance of the inverter used, leaks, etc. We cannot accept responsibility for product performance, reliability, or defect, which may arise.
- 5. We cannot accept responsibility for intellectual property of a third party, which may arise through the application of our product to your assembly with exception to those issues relating directly to the structure or method of manufacturing of our product.
- 6. Optrex will not be held responsible for any quality guarantee issue for defect products judged as Optrex-origin longer than 2 (two) years from Optrex production or 1(one) year from Optrex, Optrex America, Optrex Europe delivery which ever comes later.